

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Steven Webster, Thomas P. Glenn, Roy Dale Hollaway

Assignee: Amkor Technology, Inc.

Title: OPTICAL MODULE WITH LENS INTEGRAL HOLDER
FABRICATION METHOD

Serial No.: Unknown

Filed: Herewith

Examiner: Unknown

Group Art
Unit: Unknown

Docket No.: G0045M

Monterey, CA
January 16, 2001

Assistant Commissioner for Patents
Box PATENT APPLICATION
Washington, D.C. 20231

PRELIMINARY AMENDMENT

Dear Sir:

Prior to examination of the above-identified application,
please amend the application as follows.

IN THE CLAIMS

Please add new Claims 26-30 as follows:

- 26. A method of forming an optical module comprising:
coupling an image sensor to a base of a substrate;
forming a bond between a first surface of a mounting
surface of a lens housing and a joint surface of a sidewall of
said substrate; and
forming a bond between a second surface of said mounting
surface and an interior surface of said sidewall.

27. A method of forming an optical module comprising:
coupling an image sensor to a base of a substrate;

forming a bond between a first surface of a mounting surface of a lens housing and a joint surface of a sidewall of said substrate, said first surface of said mounting surface being parallel to said joint surface; and

forming a bond between a second surface of said mounting surface and an interior surface of said sidewall, said second surface of said mounting surface being perpendicular to said joint surface.

28. A method of forming an optical module comprising:
coupling an image sensor to a base of a substrate;
forming a bond between a first surface of a joint surface of a sidewall of said substrate and a mounting surface of a lens housing; and
forming a bond between a second surface of said joint surface and an exterior side surface of said lens housing.

29. A method of forming an optical module comprising:
coupling an image sensor to a base of a substrate;
forming a bond between a first surface of a joint surface of a sidewall of said substrate and a mounting surface of a lens housing, said first surface of said joint surface being parallel to said mounting surface; and
forming a bond between a second surface of said joint surface and an exterior side surface of said lens housing, said second surface of said joint surface being perpendicular to said mounting surface.

30. A method of forming an optical module comprising:
coupling an image sensor to a base of a first substrate of an image sensor substrate;
coupling a lens housing to said first substrate comprising:

forming a bond between a first surface of a mounting surface of said lens housing and a joint surface of a first sidewall of said first substrate; and

forming a bond between a second surface of said mounting surface and an interior surface of said first sidewall; and

snapping said image sensor substrate along a singulation street between said first sidewall of said first substrate and a second sidewall of a second substrate of said image sensor substrate.--

REMARKS

New Claims 26-30 have been added. Support for Claims 26-30 appears in the specification at least at page 2, line 9 to page 30, line 30 and in FIGS. 1-12B.

Claims 1-30 are pending in this application. If the Examiner has any questions relating to the above, the Examiner is respectfully requested to telephone the undersigned Attorney for Applicants.

EXPRESS MAIL LABEL NO:
EL579665754US

Respectfully submitted,



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